



From layout to chips

Circuits **M**ulti-**P**rojets®

MPW Services Center for ICs, Photonics, & MEMS
Prototyping & Low Volume Production

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From layout to chips

2018 CMP

Annual Users' Meeting

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Annual users' meeting introduction

- **Welcome to our 35th CMP annual users' meeting**
- This year, 71 attendees registered to participate and you are almost all here today. **Thank you for joining !**
- Full CMP 2017 activity report and 2018 technologies' portfolio,
- Partners' highlights this year will be :
 - **Andreia Cathelin, STMicro, on 28 FDSOI realizations through CMP**
 - **Etienne Nowak, CEA LETI, on NVM/130nm niche technology**
 - **Ramy Iskander, INTENTO, on EDA tools for IP management**

09:00	Registration & Welcome coffee	
09:15-09:25	Introduction	Jean-Christophe Crébier, CMP
09:25-09:40	2017 activity results	Khouldoun Torki, CMP
09:40-10:10	Performances of recent outstanding 28FDSOI circuits and systems taped out through the CMP services	Andreia Cathelin, STMicroelectronics
10:10-10:25	STMicroelectronics MPW services	Romain Verly, CMP
10:25-10:50	Adding LETI Non Volatile Memories for new design exploration	Etienne Nowak, CEA-LETI
10:50-11:00	28nm FD-SOI RTL to GDS design flow tutorial, new developments	Alexandre Chagoya, CMP
11:00-11:30	Break discussion	
11:30-11:50	ams MPW services	Khouldoun Torki, CMP
11:50-12:00	MEMS & Photonics MPW services	Azedine Manaa, CMP
12:00-12:15	Building add-on services: partners' showcase	Jean-Clément Brachet, CMP
12:15-12:35	ID-Xplore™: A Disruptive Innovation for Analog IP providers	Ramy Iskander, INTENTO
12:35-12:55	Flip-chip & Advanced packaging	Olivier Guiller, CMP
12:55-13:10	Closing remarks	Jean-Christophe Crébier, CMP
13:10-14:30	Lunch discussion	
14:30	End of CMP users annual meeting	